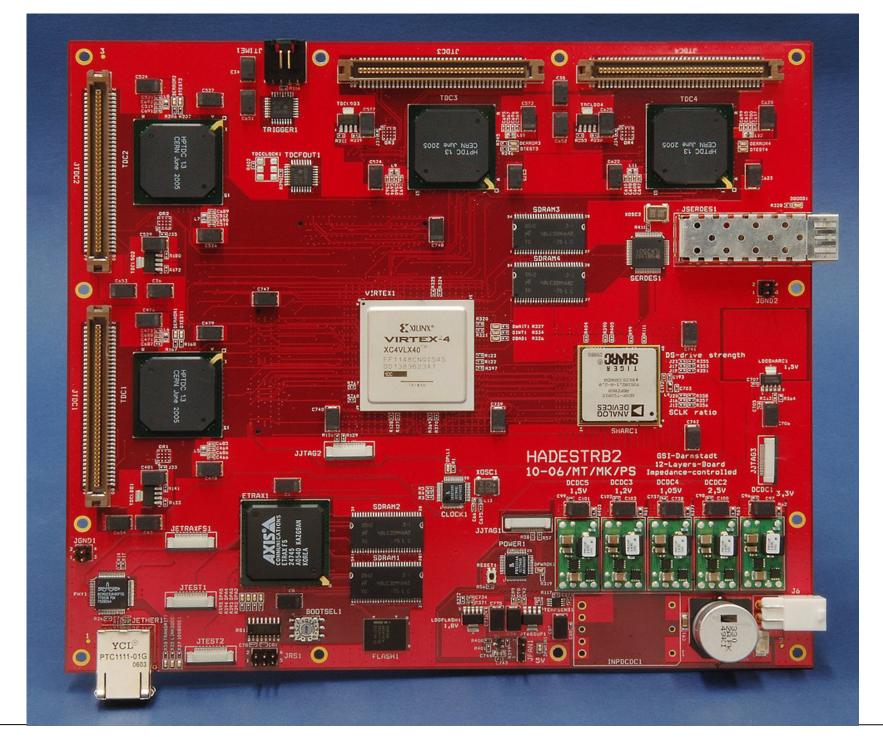
TDC and Read out Board version 3

Marcin KAJETANOWICZ Jagiellonian University

- TRB version 2
- TRB version 3
 - Specification
 - Layout
 - Application
- Current status

TRB version 2

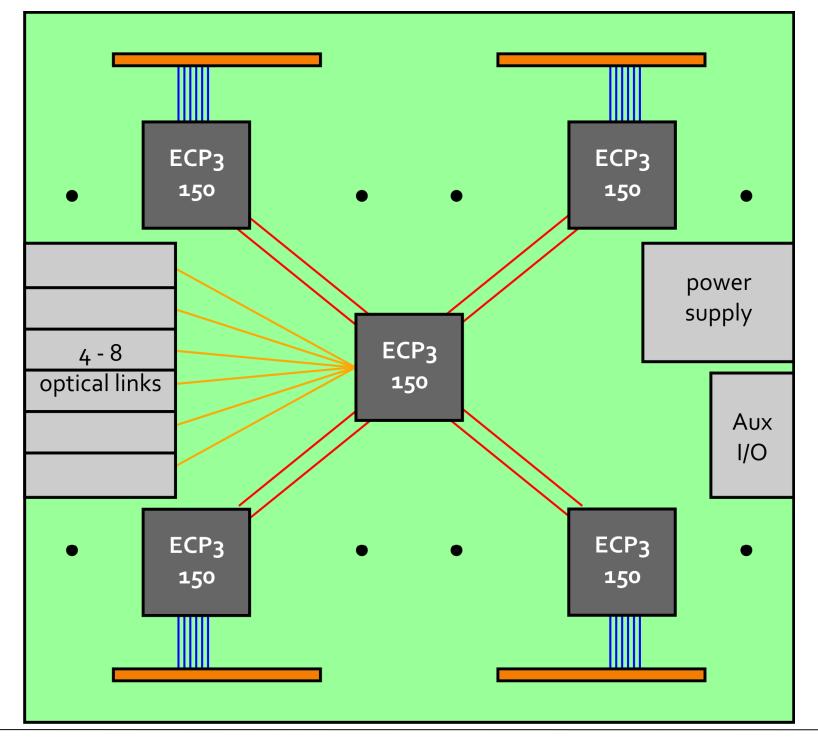
- 4 x HPTDC
- Viretx 4
- DSP (Sharc from Analog Devices)
- ETRAX FS with Linux
- SDRAM (32M x 32-bit)
- 100 Mb Ethernet
- 2.5 Gb/s optical link



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TRB version 3

- ECP3 FPGA family from Lattice
 - LFE3-150EA-8FN1156C central FPGA
 - LFE3-150EA-8FN672C edge FPGA
- 4 to 8 3.2 Gb/s optical links
- 4 208-pin I/O connectors
- 125 MHz and 200 MHz on-board oscillators
- External trigger and clock inputs
- Single 48 VDC power supply



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Mezzanine card connector

QMS family from Samtec

Performance:

Pins: up to 8.0 GHz / 16 Gbps

Supply blades: max. current: 9.2 A

Pin usage:

12-bit DQ lanes 13

2.5V lines 16

bidirectional serdes lines 6

2.5V lines from central FPGA 8

3.3V lines from central FPGA 4

four supply blades: 2 * GND, +6.5V, +3.3V

Mazzanine Card

- Edge FPGA has six serial, high speed links to the connector and 164 digital data lines
- Supply voltages: 6.5V and 3.3V

Applications:

- Adapter for a cable connection
- Optical data transmitter
- Multichannel ADC card

TRBv3 Application

- Each edge FPGA may contain up to 40 TDCs
- Time resolution confirmed by tests: <10 ps
- Edge FPGA has two high speed links to the central FPGA (up to 3.2 Gb/s)
- Central FPGA may have up to eight optical links

Status

The design complete

PCB design in progress (mid-May)

Production mid-June

From June on → tests

Code development is going on